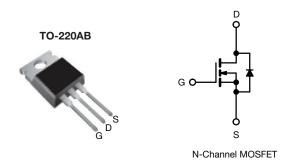


Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY				
V_{DS} (V) at T _J max.	650			
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.084		
Q _g max. (nC)	134			
Q _{gs} (nC)	16			
Q _{gd} (nC)	48			
Configuration	Single			

FEATURES

- A specific on resistance (m Ω -cm²) reduction of 25 %
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP35N60EF-GE3

PARAMETER			BOL	LIMIT	UNIT	
Drain-source voltage			os	600	V	
Gate-source voltage			ŝS	± 30	- V	
Continuous drain current ($T_{,1} = 150 \ ^{\circ}C$)	V_{GS} at 10 V $T_C = 2$	5°C		32		
Continuous drain current $(1j = 150^{\circ} C)$	V_{GS} at 10 V $T_C = 10$	0°C		20	Α	
Pulsed drain current ^a			м	80		
Linear derating factor				2.0	W/°C	
Single pulse avalanche energy ^b			NS	298	mJ	
Maximum power dissipation			D	250	W	
Operating junction and storage temperature range			T _{stg}	-55 to +150	°C	
Drain-source voltage slope $T_J = 125 \text{ °C}$		dv/	(al t	100		
Reverse diode dv/dt ^d			ai	50	V/ns	
Soldering recommendations (peak temperature) ^c For 10 s				260	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 4.6 A

c. 1.6 mm from case

d. I_{SD} = 17 A, di/dt = 300 A/µs, starting T_J = 25 °C

S20-0091-Rev. B, 17-Feb-2020

1



COMPLIANT HALOGEN

FREE



Vishay Siliconix

TYP.	MAX.	UNIT	
		UNIT	
-	62	°C/W	
-	0.5		

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						1	I
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA		600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I _D = 10 mA		0.66	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		-	4.0	V
		$\frac{V_{GS} = \pm 20 \text{ V}}{V_{GS} = \pm 30 \text{ V}}$		-	-	± 100	nA
Gate-source leakage	I _{GSS}			-	-	± 1	μA
7	I _{DSS}	V _{DS} =	V _{DS} = 480 V, V _{GS} = 0 V		-	1	μA
Zero gate voltage drain current		V _{DS} = 480 V	V _{DS} = 480 V, V _{GS} = 0 V, T _J = 125 °C		-	500	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 17 A	-	0.084	0.097	Ω
Forward transconductance ^a	9 _{fs}	V _{DS}	= 30 V, I _D = 17 A	-	8	-	S
Dynamic				•	•		
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	2568	-	-
Output capacitance	C _{oss}			-	113	-	
Reverse transfer capacitance	C _{rss}			-	7	-	
Effective output capacitance, energy related ^a	C _{o(er)}	V_{DS} = 0 V to 480 V, V_{GS} = 0 V		-	81	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}			-	421	-	
Total gate charge	Qg	V _{GS} = 10 V I _D = 17 A, V _{DS} = 480 V		-	89	134	nC
Gate-source charge	Q _{gs}			-	16	-	
Gate-drain charge	Q _{gd}			-	48	-	
Turn-on delay time	t _{d(on)}	V_{DD} = 480 V, I _D = 17 A, V _{GS} = 10 V, R _g = 9.1 Ω		-	28	56	- ns
Rise time	t _r			-	85	170	
Turn-off delay time	t _{d(off)}			-	96	192	
Fall time	t _f				61	122	
Gate input resistance	Rg	f = 1 MHz, open drain		0.2	0.5	1.0	Ω
Drain-Source Body Diode Characteristic	s	•		•	•	•	
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	32	
Pulsed diode forward current	I _{SM}			-	-	80	A
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 17 A, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}			-	150	300	ns
Reverse recovery charge	Q _{rr}	$T_{J} = 2\xi$	$5 ^{\circ}\text{C}, I_{\text{F}} = I_{\text{S}} = 17 \text{A},$	-	1.1	2.2	μC
Reverse recovery current	I _{RRM}	di/dt = 100 Å/µs, V _R = 400 V		-	14	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

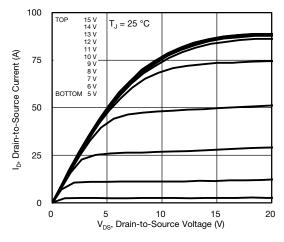


Fig. 1 - Typical Output Characteristics

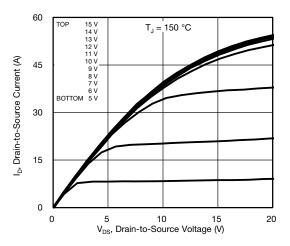


Fig. 2 - Typical Output Characteristics

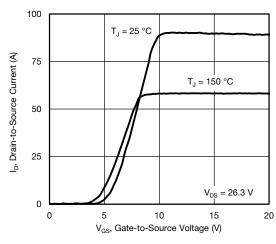


Fig. 3 - Typical Transfer Characteristics

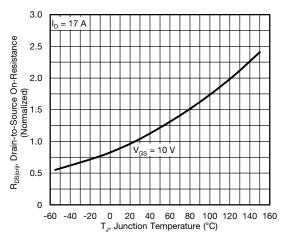


Fig. 4 - Normalized On-Resistance vs. Temperature

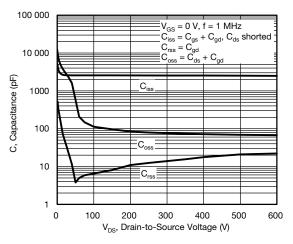


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

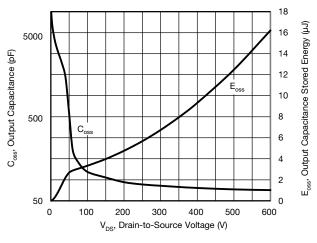


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

3

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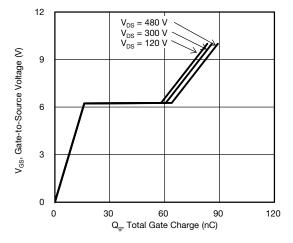


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

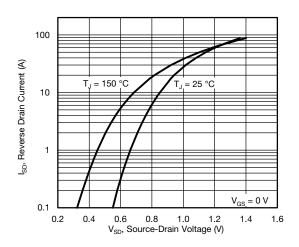
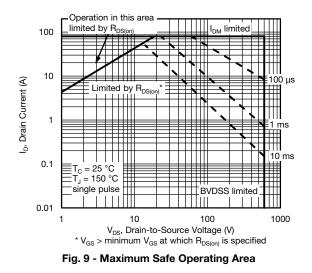


Fig. 8 - Typical Source-Drain Diode Forward Voltage



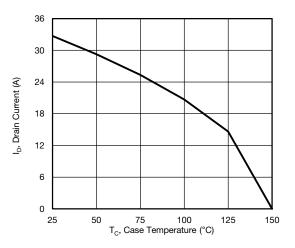


Fig. 10 - Maximum Drain Current vs. Case Temperature

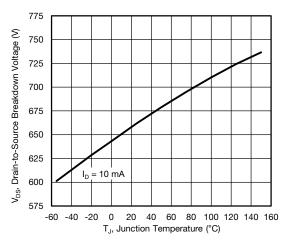
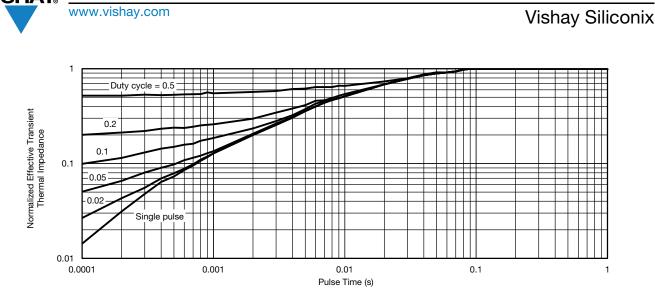
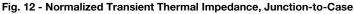


Fig. 11 - Temperature vs. Drain-to-Source Voltage

4

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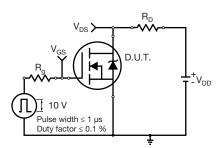


Fig. 13 - Switching Time Test Circuit

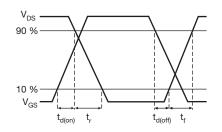


Fig. 14 - Switching Time Waveforms

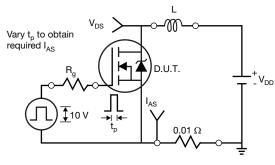


Fig. 15 - Unclamped Inductive Test Circuit

V_{DS} I_{AS} _____ Fig. 16 - Unclamped Inductive Waveforms

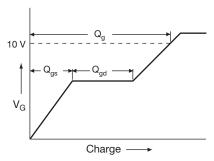


Fig. 17 - Basic Gate Charge Waveform

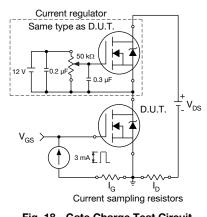
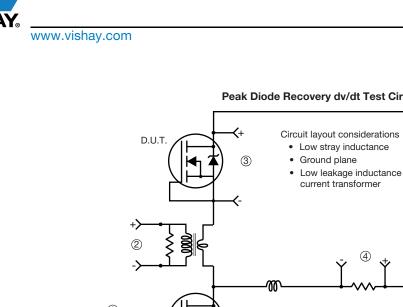


Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dv/dt Test Circuit

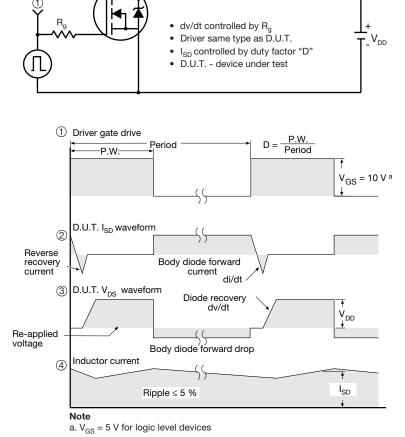


Fig. 19 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon



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Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?92107</u>.



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TO-220-1



DIM. MILLIME		IETERS	INC	HES	
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture					
ASE		Xi'an			
		IRF 9510 744K AB			

Revison: 14-Dec-15

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